

AMPMODU | AMPMODU Headers

TE Internal #: 829538-4

PCB Mount Header, Vertical, Board-to-Board, 8 Position, 2.54 mm [.

1 in] Centerline, Partially Shrouded, Gold Flash, AMPMODU

Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

Connector System: Board-to-Board

Number of Positions: 8
Number of Rows: 2

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

PCB Connector Type Connector System Board-to-Board Header Type Partially Shrouded Connector & Contact Terminates To Printed Circuit Board Connector Product Type Connector Assembly Configuration Features Number of Positions 8 Number of Rows 2 PCB Mount Orientation Vertical Board-to-Board Configuration Body Features		
Header Type Partially Shrouded Connector & Contact Terminates To Printed Circuit Board Connector Product Type Connector Assembly Configuration Features Number of Positions 8 Number of Rows 2 PCB Mount Orientation Vertical Board-to-Board Configuration Parallel	PCB Connector Type	PCB Mount Header
Connector & Contact Terminates To Printed Circuit Board Connector Product Type Connector Assembly Configuration Features Number of Positions 8 Number of Rows 2 PCB Mount Orientation Vertical Board-to-Board Configuration Parallel	Connector System	Board-to-Board
Connector Product TypeConnector AssemblyConfiguration Features8Number of Positions8Number of Rows2PCB Mount OrientationVerticalBoard-to-Board ConfigurationParallel	Header Type	Partially Shrouded
Configuration FeaturesNumber of Positions8Number of Rows2PCB Mount OrientationVerticalBoard-to-Board ConfigurationParallel	Connector & Contact Terminates To	Printed Circuit Board
Number of Positions8Number of Rows2PCB Mount OrientationVerticalBoard-to-Board ConfigurationParallel	Connector Product Type	Connector Assembly
Number of Rows2PCB Mount OrientationVerticalBoard-to-Board ConfigurationParallel	Configuration Features	
PCB Mount Orientation Vertical Board-to-Board Configuration Parallel	Number of Positions	8
Board-to-Board Configuration Parallel	Number of Rows	2
	PCB Mount Orientation	Vertical
Body Features	Board-to-Board Configuration	Parallel
	Body Features	

Primary Product Color

Contact Mating Area Plating Material Thickness .8 µm[31.5 µin]

Black



Contact Mating Area Plating Material	Gold Flash
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Connector Mounting Type	Board Mount
Mating Alignment	Without
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	PA 4.6
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC



Halogen Content	Not Low Halogen - contains Br or Cl > 900
	ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | AMPMODU Headers



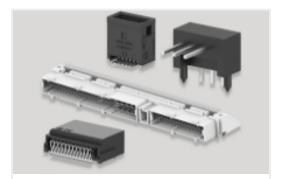
Automotive Headers(3)



Automotive Signal & Power Headers(3)



Connector Hardware(1)



PCB Headers & Receptacles(1173)



Rectangular Power Connectors(25)



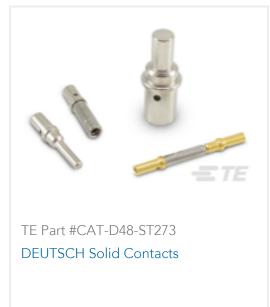
Wire-to-Board Headers & Receptacles (78)

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Customers Also Bought



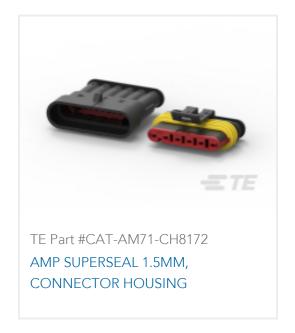












Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_829538-4_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_829538-4_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_829538-4_F.3d_stp.zip

English

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